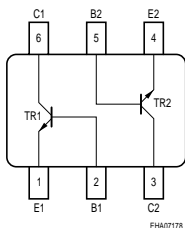
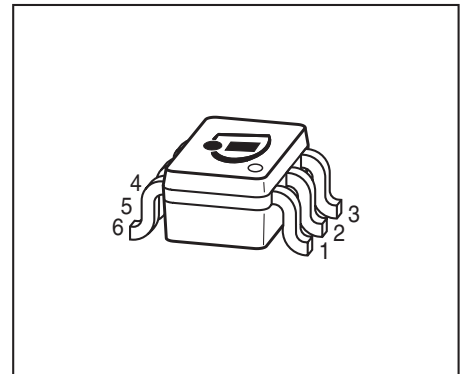


## NPN Silicon AF Transistor Array

- Precision matched transistor pair:  $\Delta I_C \leq 10\%$
- For current mirror applications
- Low collector-emitter saturation voltage
- Two (galvanic) internal isolated Transistors
- Complementary type: BCM856S
- BCM846S: For orientation in reel see package information below
- Pb-free (RoHS compliant) package
- Qualified according AEC Q101



| Type    | Marking | Pin Configuration |      |      |      |      |      | Package |
|---------|---------|-------------------|------|------|------|------|------|---------|
| BCM846S | 1Ms     | 1=E1              | 2=B1 | 3=C2 | 4=E2 | 5=B2 | 6=C1 | SOT363  |

## Maximum Ratings

| Parameter                                  | Symbol    | Value       | Unit |
|--|-----------|-------------|------|
| Collector-emitter voltage                  | $V_{CEO}$ | 65          | V    |
| Collector-emitter voltage                  | $V_{CES}$ | 80          |      |
| Collector-base voltage                     | $V_{CBO}$ | 80          |      |
| Emitter-base voltage                       | $V_{EBO}$ | 6           |      |
| Collector current                          | $I_C$     | 100         | mA   |
| Peak collector current, $t_p \leq 10$ ms   | $I_{CM}$  | 200         |      |
| Total power dissipation-<br>$T_S = 115$ °C | $P_{tot}$ | 250         | mW   |
| Junction temperature                       | $T_j$     | 150         | °C   |
| Storage temperature                        | $T_{stg}$ | -65 ... 150 |      |

**Thermal Resistance**

| Parameter                                | Symbol     | Value | Unit |
|--|------------|-------|------|
| Junction - soldering point <sup>1)</sup> | $R_{thJS}$ | 140   | K/W  |

**Electrical Characteristics at  $T_A = 25^\circ\text{C}$ , unless otherwise specified**

| Parameter | Symbol | Values |      |      | Unit |
|-----------|--------|--------|------|------|------|
|           |        | min.   | typ. | max. |      |

**DC Characteristics**

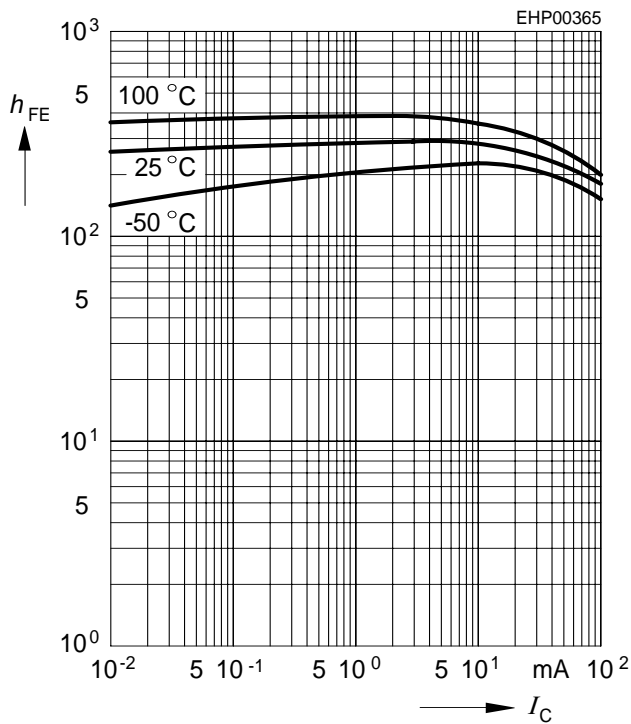
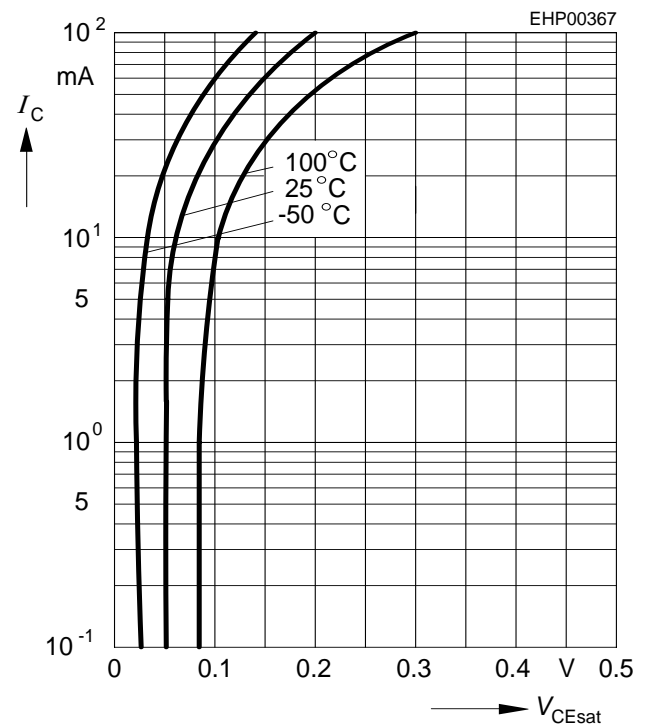
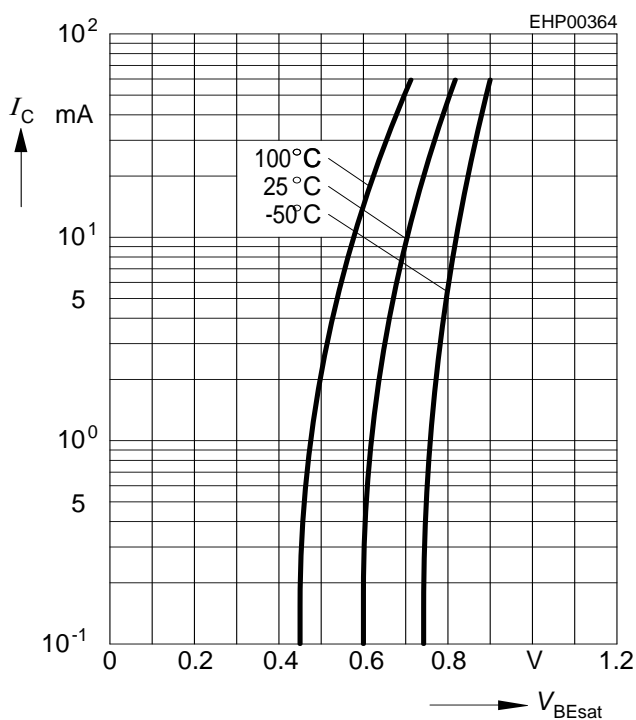
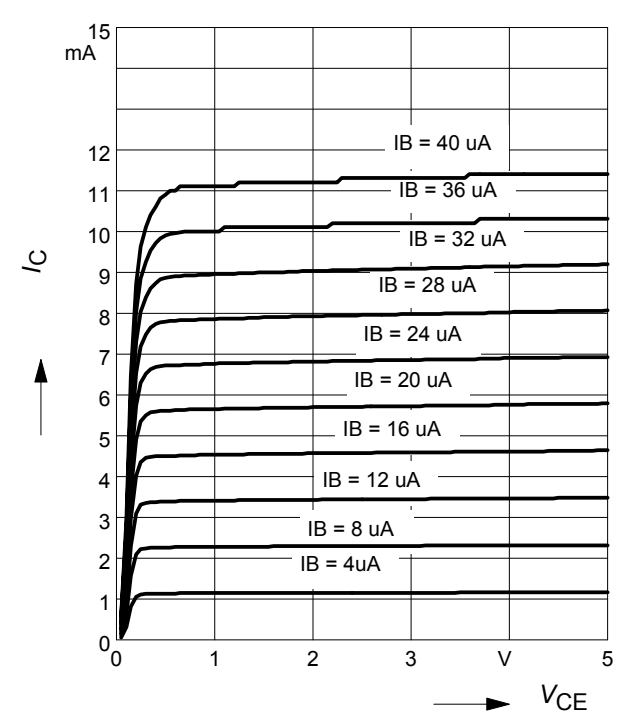
|  |               |            |            |            |               |
|--|---------------|------------|------------|------------|---------------|
| Collector-emitter breakdown voltage<br>$I_C = 10\text{ mA}, I_B = 0\text{ A}$  | $V_{(BR)CEO}$ | 65         | -          | -          | V             |
| Collector-base breakdown voltage<br>$I_C = 10\text{ }\mu\text{A}, I_E = 0\text{ A}$  | $V_{(BR)CBO}$ | 80         | -          | -          |               |
| Collector-emitter breakdown voltage<br>$I_C = 10\text{ }\mu\text{A}, V_{BE} = 0\text{ A}$  | $V_{(BR)CES}$ | 80         | -          | -          |               |
| Emitter-base breakdown voltage<br>$I_E = 10\text{ }\mu\text{A}, I_C = 0\text{ A}$  | $V_{(BR)EBO}$ | 6          | -          | -          |               |
| Collector-base cutoff current<br>$V_{CB} = 30\text{ V}, I_E = 0\text{ A}$<br>$V_{CB} = 30\text{ V}, I_E = 0\text{ A}, T_A = 150\text{ }^\circ\text{C}$ | $I_{CBO}$     | -<br>-     | -<br>-     | 0.015<br>5 | $\mu\text{A}$ |
| DC current gain <sup>-2)</sup><br>$I_C = 10\text{ }\mu\text{A}, V_{CE} = 5\text{ V}$<br>$I_C = 2\text{ mA}, V_{CE} = 5\text{ V}$                       | $h_{FE}$      | -<br>200   | 250<br>290 | -<br>450   | -             |
| Collector-emitter saturation voltage <sup>2)</sup><br>$I_C = 10\text{ mA}, I_B = 0.5\text{ mA}$<br>$I_C = 100\text{ mA}, I_B = 5\text{ mA}$            | $V_{CEsat}$   | -<br>-     | 90<br>200  | 300<br>650 | mV            |
| Base emitter saturation voltage <sup>2)</sup><br>$I_C = 10\text{ mA}, I_B = 0.5\text{ mA}$<br>$I_C = 100\text{ mA}, I_B = 5\text{ mA}$                 | $V_{BEsat}$   | -<br>-     | 700<br>900 | -<br>-     |               |
| Base-emitter voltage <sup>-2)</sup><br>$I_C = 2\text{ mA}, V_{CE} = 5\text{ V}$<br>$I_C = 10\text{ mA}, V_{CE} = 5\text{ V}$                           | $V_{BE(ON)}$  | 580<br>-   | 660<br>-   | 700<br>770 |               |
| Matching<br>$I_B = 1\text{ }\mu\text{A}, V_{CE1} = V_{CE2} = 1.0\text{ V}$<br>$I_B = 100\text{ }\mu\text{A}, V_{CE1} = V_{CE2} = 1.0\text{ V}$         | $\Delta I_C$  | -10<br>-10 | -<br>-     | 10<br>10   | %             |

<sup>1)</sup>For calculation of  $R_{thJA}$  please refer to Application Note AN077 (Thermal Resistance Calculation)

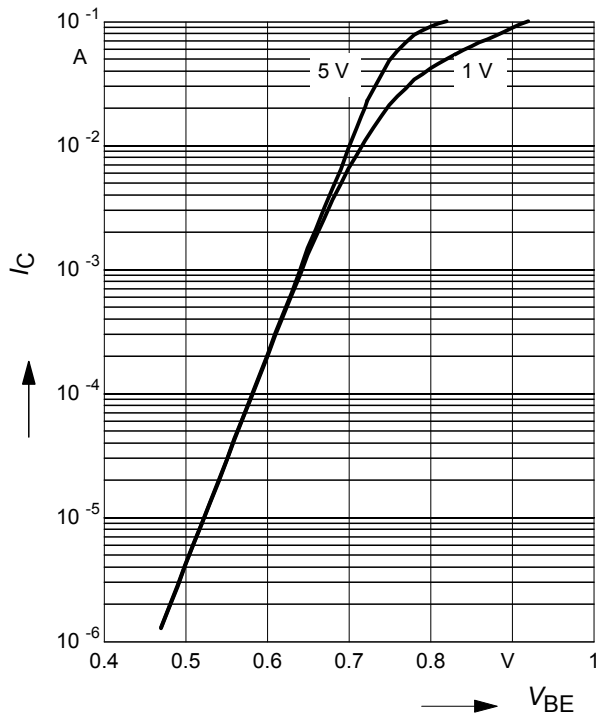
<sup>2)</sup>Puls test:  $t < 300\mu\text{s}$ ;  $D < 2\%$

**Electrical Characteristics** at  $T_A = 25^\circ\text{C}$ , unless otherwise specified

| Parameter  | Symbol    | Values |      |      | Unit             |
|--|-----------|--------|------|------|------------------|
|  |           | min.   | typ. | max. |                  |
| AC Characteristics   |           |        |      |      |                  |
| Transition frequency<br>$I_C = 20\text{ mA}$ , $V_{CE} = 5\text{ V}$ , $f = 100\text{ MHz}$  | $f_T$     | -      | 250  | -    | MHz              |
| Collector-base capacitance<br>$V_{CB} = 10\text{ V}$ , $f = 1\text{ MHz}$  | $C_{cb}$  | -      | 0.95 | -    | pF               |
| Emitter-base capacitance<br>$V_{EB} = 0.5\text{ V}$ , $f = 1\text{ MHz}$   | $C_{eb}$  | -      | 9    | -    |                  |
| Short-circuit input impedance<br>$I_C = 2\text{ mA}$ , $V_{CE} = 5\text{ V}$ , $f = 1\text{ kHz}$  | $h_{11e}$ | -      | 4.5  | -    | kΩ               |
| Open-circuit reverse voltage transf. ratio<br>$I_C = 2\text{ mA}$ , $V_{CE} = 5\text{ V}$ , $f = 1\text{ kHz}$                           | $h_{12e}$ | -      | 2    | -    | 10 <sup>-4</sup> |
| Short-circuit forward current transf. ratio<br>$I_C = 2\text{ mA}$ , $V_{CE} = 5\text{ V}$ , $f = 1\text{ kHz}$                          | $h_{21e}$ | -      | 330  | -    | -                |
| Open-circuit output admittance<br>$I_C = 2\text{ mA}$ , $V_{CE} = 5\text{ V}$ , $f = 1\text{ kHz}$                                       | $h_{22e}$ | -      | 30   | -    | μS               |
| Noise figure<br>$I_C = 200\text{ μA}$ , $V_{CE} = 5\text{ V}$ , $f = 1\text{ kHz}$ ,<br>$\Delta f = 200\text{ Hz}$ , $R_S = 2\text{ kΩ}$ | $F$       | -      | -    | 10   | dB               |

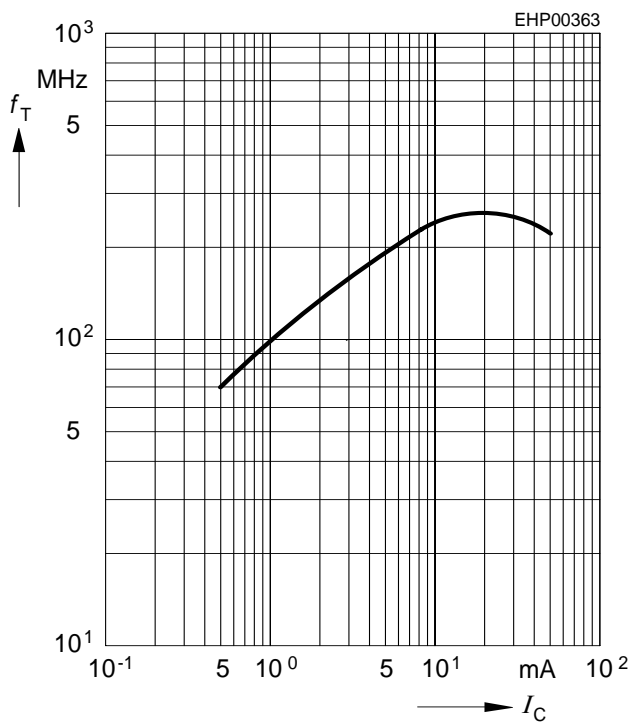
**DC current gain  $h_{FE} = f(I_C)$** 
 $V_{CE} = 5V$ 

**Collector-emitter saturation voltage**
 $I_C = f(V_{CEsat}), h_{FE} = 20$ 

**Base-emitter saturation voltage**
 $I_C = f(V_{BEsat}), h_{FE} = 20$ 

**Output characteristics  $I_C = f(V_{CE})$ ,**
 $I_B = \text{parameter}$ 


**Collector current  $I_C = f(V_{BE})$**



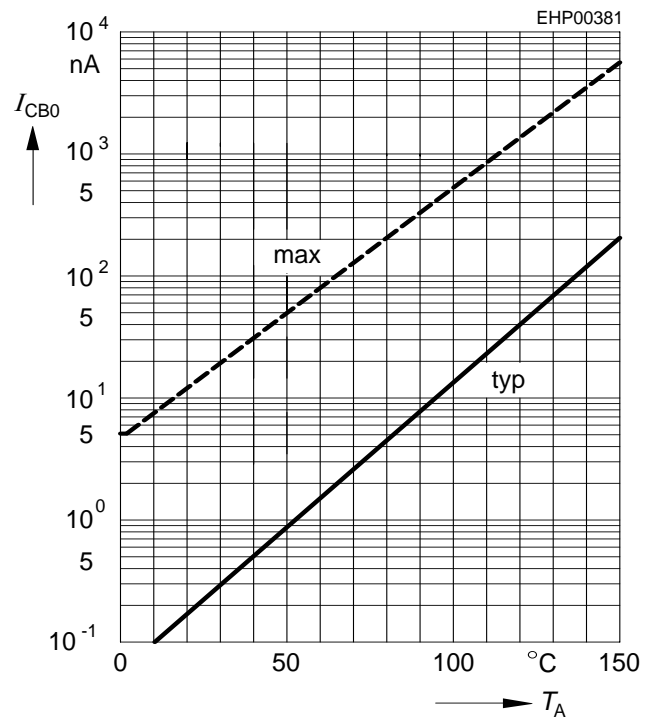
**Transition frequency  $f_T = f(I_C)$**

$V_{CE} = \text{parameter in V, } f = 2\text{ GHz}$



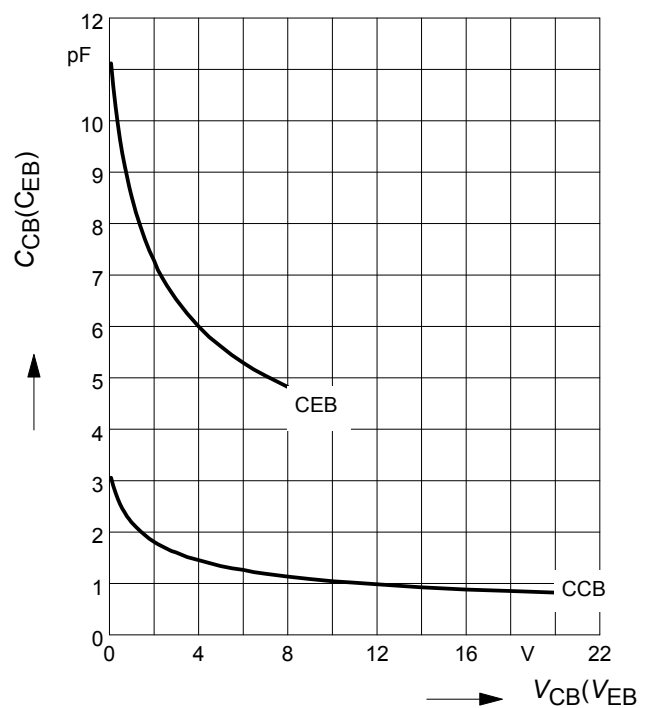
**Collector cutoff current  $I_{CBO} = f(T_A)$**

$V_{CBO} = 30\text{ V}$

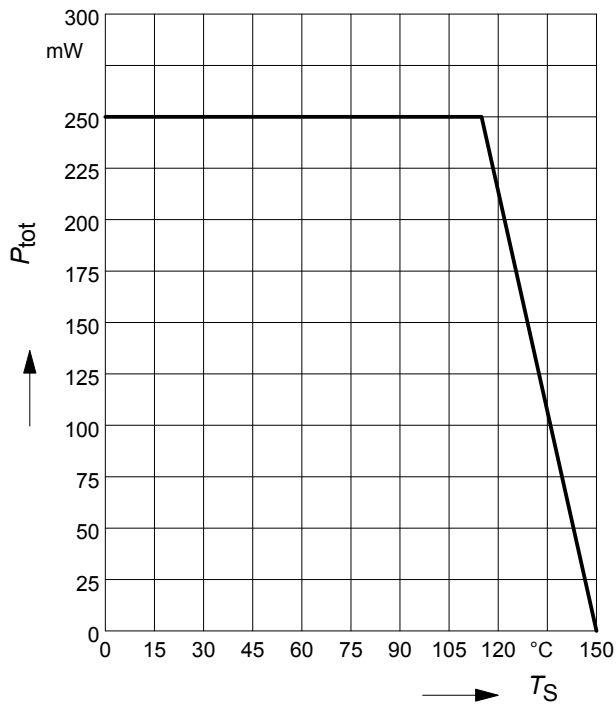


**Collector-base capacitance  $C_{cb} = f(V_{CB})$**

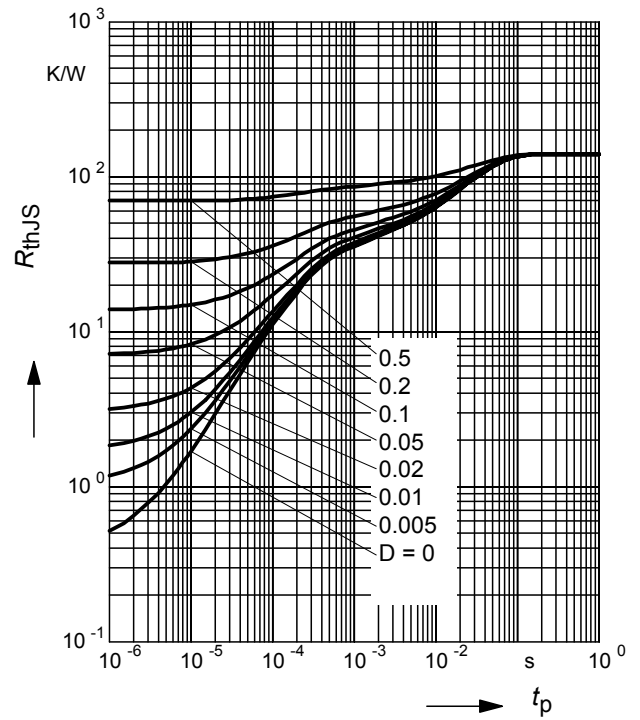
**Emitter-base capacitance  $C_{eb} = f(V_{EB})$**



**Total power dissipation**  $P_{\text{tot}} = f(T_S)$

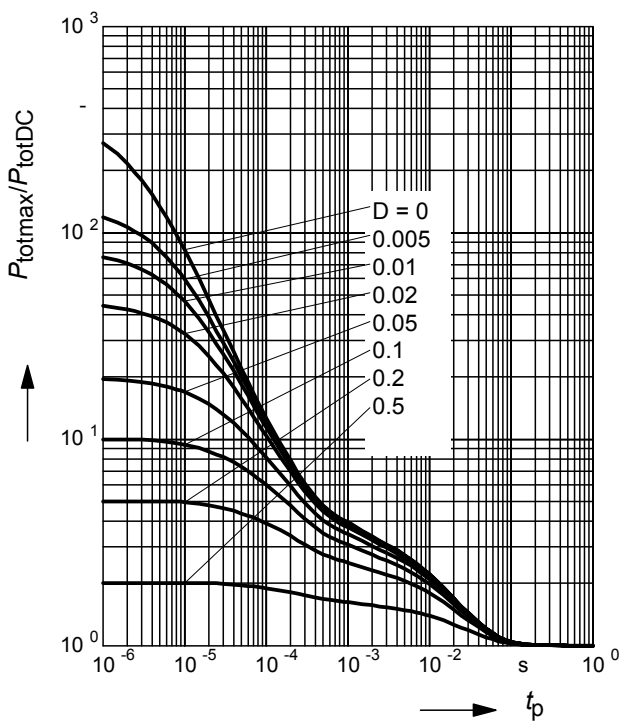


**Permissible Pulse Load**  $R_{\text{thJS}} = f(t_p)$



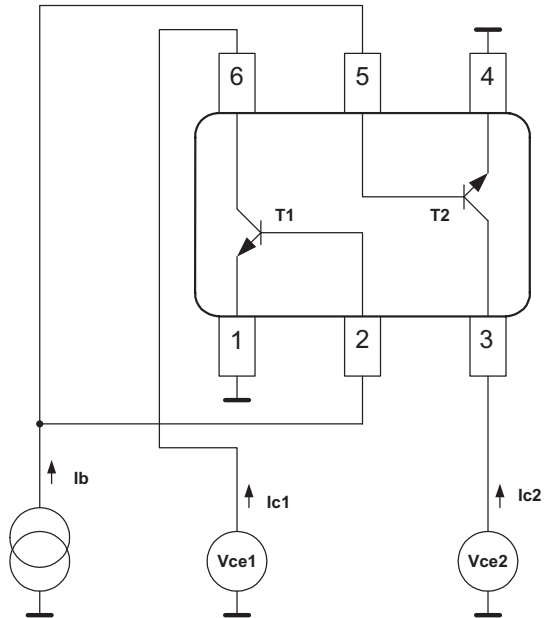
**Permissible Pulse Load**

$P_{\text{totmax}}/P_{\text{totDC}} = f(t_p)$



### Definition of matching

$$\Delta I_C = (I_{C2} - I_{C1}) / I_{C1}$$



Manufacture are possible.

The diagram shows a rectangular integrated circuit package with eight pins. The top surface of the package is marked with the text 'WH S 06' and '5'. A small circle is located in the bottom-left corner of the package. Labels with leader lines point to these features: 'Infineon technologies' (Manufacturer) points to the top of the package; '2005, June' (Date code (Year/Month)) points to the '06' in the marking; 'Pin 1 marking' (Laser marking) points to the small circle; and 'BCR108S' (Type code) points to the 'S' in the marking.

Infineon  
technologies

Manufacturer

2005, June  
Date code (Year/Month)

Pin 1 marking  
Laser marking

BCR108S  
Type code



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